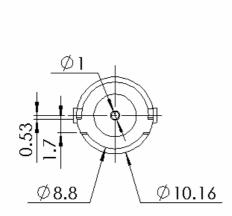
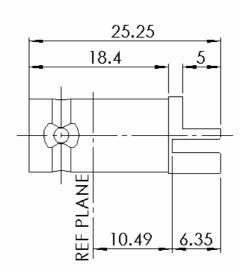
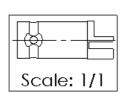
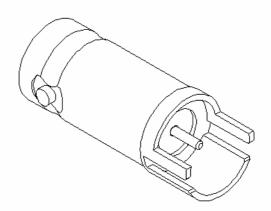
R142.568.703

Series: BNC 75 HDTV









All dimensions are in mm.



| COMPONENTS | MATERIALS | PLATING (μm) | |
|---|-----------------------------------|--------------|--|
| BODY CENTER CONTACT OUTER CONTACT INSULATOR GASKET OTHERS PARTS | BRASS BERYLLIUM COPPER PTFE | NPGR NPGR | |
| - | - - | - | |

Issue: 0836

In the effort to improve our products, we reserve the right to make changes judged to be necessary



R142.568.703

Series: BNC 75 HDTV

PACKAGING

| Standard | Unit | Other |
|----------|------------|------------|
| 100 | 'W' option | Contact us |

SPECIFICATION

ELECTRICAL CHARACTERISTICS

Impedance 75 Ω Frequency **0-6** GHz

VSWR 1.04 + **0.020** x F(GHz) Maxi Insertion loss

0.1 $\sqrt{F(GHz)}$ dB Maxi RF leakage **55*** - F(GHz)) dB Maxi

Voltage rating 500 Veff Maxi Dielectric withstanding voltage 1500 Veff mini Insulation resistance **5000** M Ω mini

ENVIRONMENTAL

-65/+165 ° C Operating temperature

Hermetic seal NA Atm.cm3/s Panel leakage NA

OTHER CHARACTERISTICS

Assembly instruction

Others:

* From 2 to 3GHz

MECHANICAL CHARACTERISTICS

Center contact retention

Axial force – Mating end 18 N mini Axial force – Opposite end 18 N mini Torque NA N.cm mini

Recommended torque

Mating NA N.cm Panel nut NA N.cm

Mating life 1000 Cycles mini

5.940 g Weight

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R142.568.703

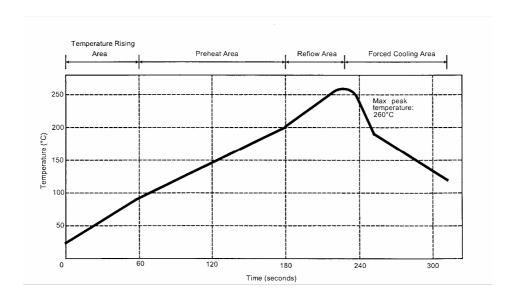
Series: BNC 75 HDTV

SOLDER PROCEDURE

- 1. Deposit solder paste 'Sn Ag4 Cu0.5' on mounting zone by screen printing application. We recommend a low residue flux.
 - We advise a thickness of 150 microm (5.850 microinch). Verify that the edges of the zone are clean.
- 2. Placement of the receptacle on the mounting zone with an automatic machine of 'pick and place' type. A video camera is recommended for positioning of the component. Adhesive agents must not be used on the receptacle.
- 3. This process of soldering has been tested with convection oven .Below please find ,the typical profile to use.
- 4. The cleaning of printed circuit boards is not obliged .
- 5. Verification of solder joints and position of the component by visual inspection.

NOTE: The receptacle and the plug must not be mated before completion of this procedure

TEMPERATURE PROFILE



| Parameter | Value | Unit |
|----------------------------------|-----------|--------|
| Temperature rising Area | 1 - 4 | °C/sec |
| Max Peak Temperature | 260 | °C |
| Max dwell time @260°C | 10 | sec |
| Min dwell time @235°C | 20 | sec |
| Max dwell time @235°C | 60 | sec |
| Temperature drop in cooling Area | -1 to - 4 | °C/sec |
| Max dwell time above 100°C | 420 | sec |

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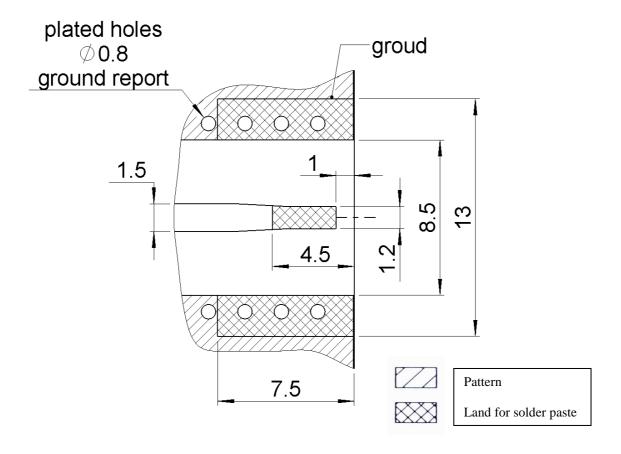
necessary.



R142.568.703

Series: BNC 75 HDTV

PCB for BNC - INFORMATIONS



Thickness of PCB: .063 (1.6 mm) Material: Rogers RO4350 (Er=3.48)

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